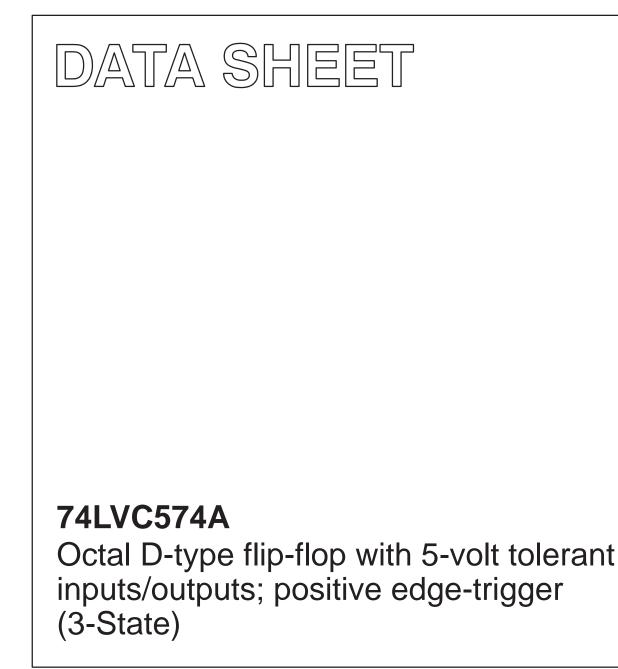
## INTEGRATED CIRCUITS



Product specification

1998 Jul 29



Philips Semiconductors

## 74LVC574A

#### FEATURES

- 5-volt tolerant inputs/outputs, for interfacing with 5-volt logic
- Supply voltage range of 2.7V to 3.6V
- Complies with JEDEC standard no. 8-1A
- Inputs accept voltages up to 5.5V
- CMOS low power consumption
- Direct interface with TTL levels
- High impedance when V<sub>CC</sub> = 0V
- 8-bit positive edge-triggered register
- Independent register and 3-State buffer operation
- Flow-through pin-out architecture

#### DESCRIPTION

The 74LVC574A is a high-performance, low-power, low-voltage, Si-gate CMOS device, superior to most advanced CMOS compatible TTL families.

#### QUICK REFERENCE DATA

GND = 0V;  $T_{amb} = 25^{\circ}C$ ;  $t_r = t_f \le 2.5ns$ 

Inputs can be driven from either 3.3V or 5V devices. In 3-State operation, outputs can handle 5V. This feature allows the use of these devices as translators in a mixed 3.3V/5V environment.

The 74LVC574A is an octal D-type flip-flop featuring separate D-type inputs for each flip-flop and 3-State outputs for bus-oriented applications. A clock (CP) and an output enable (OE) input are common to all flip-flops.

The eight flip-flops will store the state of their individual D-inputs that meet the setup and hold times requirements on the LOW-to-HIGH CP transition.

When OE is LOW, the contents of the eight flip-flops is available at the outputs. When  $\overline{OE}$  is HIGH, the outputs go to the high impedance OFF-state. Operation of the OE input does not affect the state of the flip-flops.

The '574A' is functionally identical to the '374A', but the '374A' has a different pin arrangement.

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t <sub>PHL</sub> /t <sub>PLH</sub>	Propagation delay CP to Q <sub>n</sub>	$C_{L} = 50 pF$ $V_{CC} = 3.3 V$	4.8	ns
f <sub>max</sub>	maximum clock frequency		150	MHz
CI	Input capacitance		5.0	pF
C <sub>PD</sub>	Power dissipation capacitance per flip-flop	Notes 1 and 2	20	pF

NOTE:

 $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ): 1.

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_0)$  where:  $f_i = \text{input frequency in MHz}; C_L = \text{output load capacity in pF};$   $f_0 = \text{output frequency in MHz}; V_{CC} = \text{supply voltage in V};$ 

 $\Sigma$  (C<sub>L</sub> x V<sub>CC</sub><sup>2</sup> x f<sub>o</sub>) = sum of outputs.

The condition is V<sub>I</sub> = GND to V<sub>CC</sub>

#### ORDERING INFORMATION

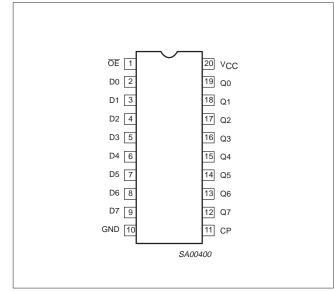
PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
20-Pin Plastic Shrink Small Outline (SO)	–40°C to +85°C	74LVC574A D	74LVC574A D	SOT163-1
20-Pin Plastic Shrink Small Outline (SSOP) Type II	–40°C to +85°C	74LVC574A DB	74LVC574A DB	SOT339-1
20-Pin Plastic Thin Shrink Small Outline (TSSOP) Type I	–40°C to +85°C	74LVC574A PW	7LVC574APW DH	SOT360-1

## 74LVC574A

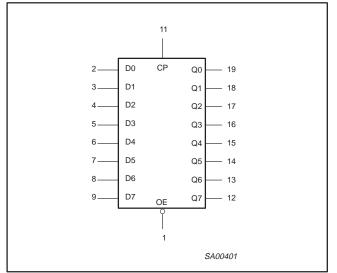
#### **PIN DESCRIPTION**

PIN NUMBER	SYMBOL	FUNCTION
1	ŌĒ	Output enable input (active-Low)
2, 3, 4, 5, 6, 7, 8, 9	D0-D7	Data inputs
19, 18, 17, 16, 15, 14, 13, 12	Q0-Q7	Data outputs
10	GND	Ground (0V)
11	СР	Clock input (LOW-to-HIGH, edge-triggered)
20	V <sub>CC</sub>	Positive supply voltage

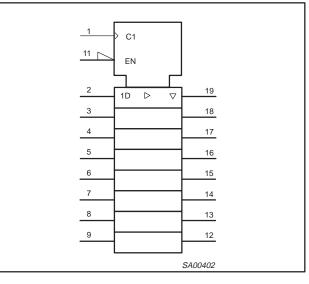
#### **PIN CONFIGURATION**



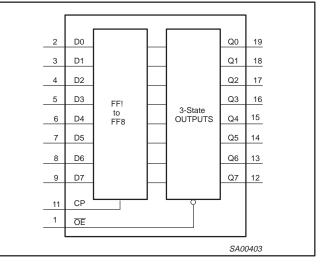
#### LOGIC SYMBOL



#### LOGIC SYMBOL (IEEE/IEC)

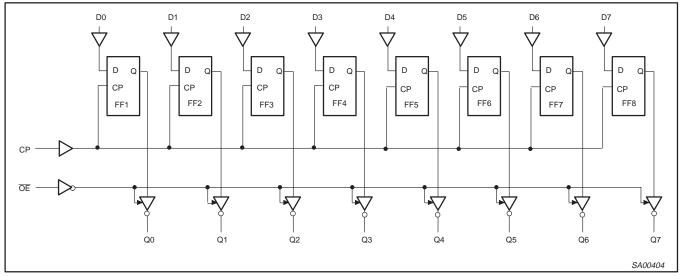


#### FUNCTIONAL DIAGRAM



### 74LVC574A

#### LOGIC DIAGRAM



#### FUNCTION TABLE

OPERATING MODES		INPUTS		INTERNAL FLIP-FLOPS	OUTPUTS
OFERATING MODES	ŌE	LE	D <sub>n</sub>	INTERNAL FLIF-FLOFS	Q <sub>0</sub> to Q <sub>7</sub>
Load and read register	L	Î	l h	L H	L H
Load register and disable outputs	H H	1	l h	L H	Z Z

H = HIGH voltage level

h = HIGH voltage level one setup time prior to the LOW-to-HIGH CP transition

L = LOW voltage level

I = LOW voltage level one setup time prior to the LOW-to-HIGH CP transition

Z = High impedance OFF-state

↑ = LOW-to-HIGH clock transition

#### **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER	CONDITIONS	LIM	UNIT		
STMBOL	PARAMETER	CONDITIONS	MIN	MAX		
N	DC supply voltage (for max. speed performance)		2.7	3.6	V	
V <sub>CC</sub>	DC supply voltage (for low-voltage applications)		1.2	3.6	v	
VI	DC Input voltage range		0	5.5	V	
Vo	DC output voltage range; output HIGH or LOW state		0	V <sub>CC</sub>	V	
	DC output voltage range; output 3-State		0	5.5		
T <sub>amb</sub>	Operating ambient temperature range in free-air		-40	+85	°C	
t <sub>r</sub> , t <sub>f</sub>	Input rise and fall times	$V_{CC} = 1.2 \text{ to } 2.7 \text{V}$ $V_{CC} = 2.7 \text{ to } 3.6 \text{V}$	0 0	20 10	ns/V	

### 74LVC574A

#### ABSOLUTE MAXIMUM RATINGS<sup>1</sup>

In accordance with the Absolute Maximum Rating System (IEC 134) Voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT	
V <sub>CC</sub>	DC supply voltage		-0.5 to +6.5	V	
I <sub>IK</sub>	DC input diode current	V <sub>I</sub> <0	-50	mA	
VI	DC input voltage	Note 2	-0.5 to +6.5	V	
I <sub>OK</sub>	DC output diode current	$V_{O} > V_{CC} \text{ or } V_{O} < 0$	±50	mA	
ν.	DC output voltage; output HIGH or LOW state	Note 2	–0.5 to V <sub>CC</sub> +0.5	V	
Vo	DC output voltage; output 3-State	Note 2	-0.5 to 6.5	V	
Ι <sub>Ο</sub>	DC output source or sink current	$V_{O} = 0$ to $V_{CC}$	±50	mA	
I <sub>GND</sub> , I <sub>CC</sub>	DC V <sub>CC</sub> or GND current		±100	mA	
T <sub>stg</sub>	Storage temperature range		-65 to +150	°C	
Ртот	Power dissipation per package – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	500 500	mW	

#### NOTES:

 Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

#### DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions voltages are referenced to GND (ground = 0V)

			L	LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	Temp = -40°C to +85°C			UNIT	
			MIN	MIN TYP <sup>1</sup> MAX		1	
		$V_{CC} = 1.2V$	V <sub>CC</sub>			v	
V <sub>IH</sub>	HIGH level Input voltage	V <sub>CC</sub> = 2.7 to 3.6V	2.0			1 `	
M		V <sub>CC</sub> = 1.2V			GND	v	
$V_{IL}$	LOW level Input voltage	V <sub>CC</sub> = 2.7 to 3.6V			0.8	1	
		$V_{CC} = 2.7V; V_I = V_{IH} \text{ or } V_{IL}; I_O = -12mA$	V <sub>CC</sub> -0.5				
M		$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = -100 \mu A$	V <sub>CC</sub> -0.2	V <sub>CC</sub>			
V <sub>OH</sub>	HIGH level output voltage	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = -18\text{mA}$	V <sub>CC</sub> -0.6			1 `	
		$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = -24\text{mA}$	V <sub>CC</sub> -0.8			1	
		$V_{CC} = 2.7V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 12mA$			0.40		
V <sub>OL</sub>	LOW level output voltage	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$		GND	0.20	V	
		$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 24 \text{mA}$			0.55	1	
ł <sub>l</sub>	Input leakage current <sup>2</sup>	$V_{CC} = 3.6V; V_1 = 5.5V \text{ or GND}$		±0.1	±5	μΑ	
I <sub>OZ</sub>	3-State output OFF-state current	$V_{CC} = 3.6V; V_I = V_{IH} \text{ or } V_{IL}; V_O = 5.5V \text{ or GND}$		0.1	±10	μΑ	
I <sub>off</sub>	Power off leakage supply	$V_{CC} = 0.0V; V_{I} \text{ or } V_{O} = 5.5V$		0.1	±10	μA	
I <sub>CC</sub>	Quiescent supply current	$V_{CC} = 3.6V; V_I = V_{CC} \text{ or GND}; I_O = 0$		0.1	10	μA	
$\Delta I_{CC}$	Additional quiescent supply current per input pin	$V_{CC} = 2.7V$ to 3.6V; $V_{I} = V_{CC} - 0.6V$ ; $I_{O} = 0$		5	500	μA	

#### NOTES:

1. All typical values are at  $V_{CC}$  = 3.3V and  $T_{amb}$  = 25°C.

2. The specified overdrive current at the data input forces the data input to the opposite logic input state.

### 74LVC574A

#### **AC CHARACTERISTICS**

 $GND = 0V; t_r = t_f \ \le \ 2.5ns; \ C_L = 50pF; \ R_L = 500\Omega; \ T_{amb} = -40^\circ C \ to \ +85^\circ C.$ 

			LIMITS						
SYMBOL	PARAMETER	WAVEFORM	V <sub>CC</sub>	; = 3.3V ±0	).3V	V <sub>CC</sub> =	= 2.7V	V <sub>CC</sub> = 1.2V	UNIT
			MIN	TYP <sup>1</sup>	MAX	MIN	MAX	TYP	1
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation delay CP to Q <sub>n</sub>	1, 4	1.5	4.8	7.0	1.5	8.0	21	ns
t <sub>PZH</sub> t <sub>PZL</sub>	3-State output enable time $\overline{\text{OE}}$ to $\text{Q}_{\text{n}}$	2, 4	1.5	4.0	7.5	1.5	8.5	17	ns
t <sub>PHZ</sub> t <sub>PLZ</sub>	3-State output disable time $\overline{\text{OE}}$ to $Q_n$	2, 4	1.5	3.5	6.0	1.5	6.5	11	ns
t <sub>W</sub>	Clock pulse width HIGH or LOW	1	3.4	1.7	-	3.4	-	-	ns
t <sub>SU</sub>	Setup time D <sub>n</sub> to CP	3	2.0	0.3	-	2.0	-	-	ns
t <sub>h</sub>	Hold time D <sub>n</sub> to CP	3	1.5	-0.2	-	1.5	-	-	ns
f <sub>max</sub>	Maximum clock pulse frequency	1	100		-	80	-	-	MHz

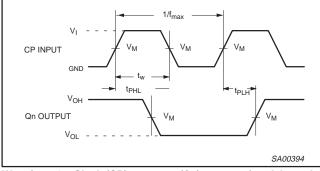
NOTE:

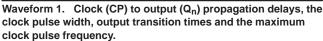
Unless otherwise stated, all typical values are at V<sub>CC</sub> = 3.3V and T<sub>amb</sub> = 25°C.

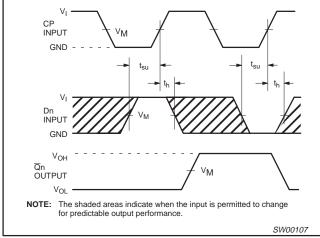
#### AC WAVEFORMS

 $V_M$  = 1.5V at  $V_{CC} \ge$  2.7V;  $V_M$  = 0.5  $V_{CC}$  at  $V_{CC} <$  2.7V.  $V_{OL}$  and  $V_{OH}$  are the typical output voltage drop that occur with the output load.

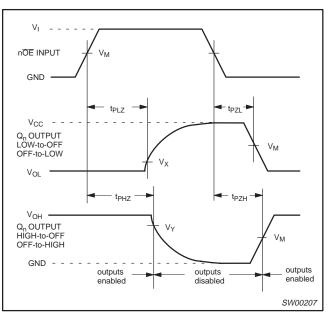
 $V_X$  =  $V_{OL}$  + 0.3V at  $V_{CC}$   $\geq$  2.7V;  $V_X$  =  $V_{OL}$  + 0.1  $V_{CC}$  at  $V_{CC}$  < 2.7V  $V_Y$  =  $V_{OH}$  –0.3V at  $V_{CC}$   $\geq$  2.7V;  $V_Y$  =  $V_{OH}$  –0.1  $V_{CC}$  at  $V_{CC}$  < 2.7V



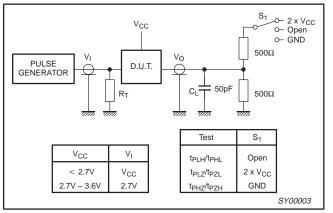




Waveform 2. Data setup and hold times for the D<sub>n</sub> input to the CP input.



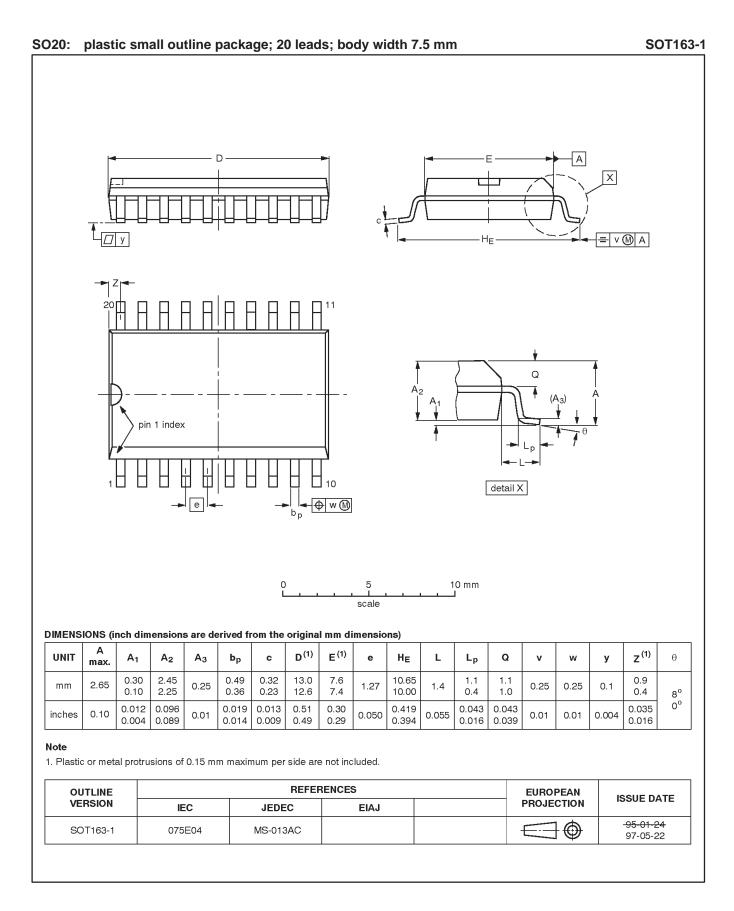
## Waveform 3. 3-State enable and disable times. TEST CIRCUIT



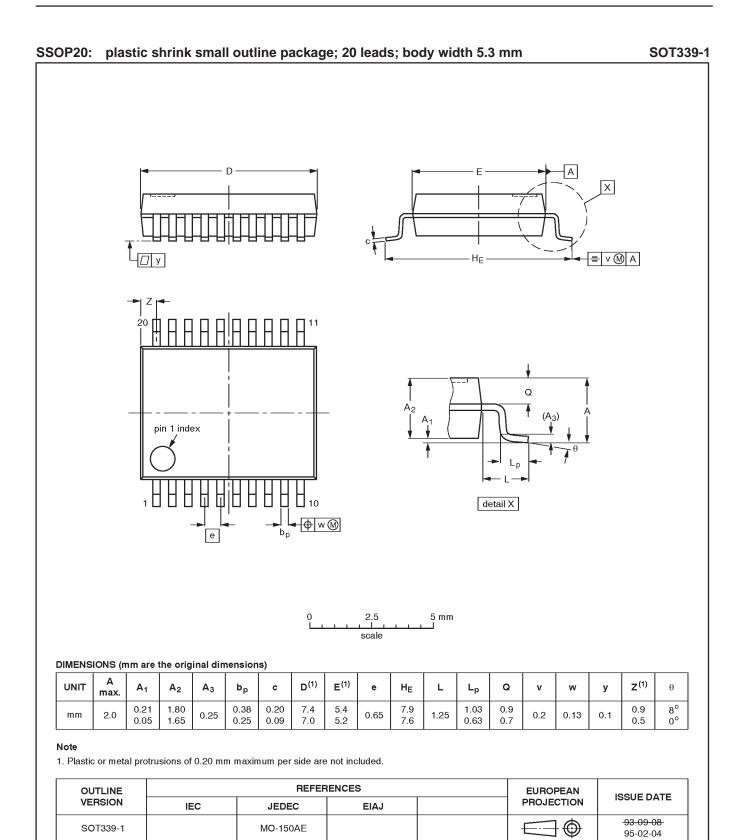
Waveform 4. Load circuitry for switching times.

## Product specification

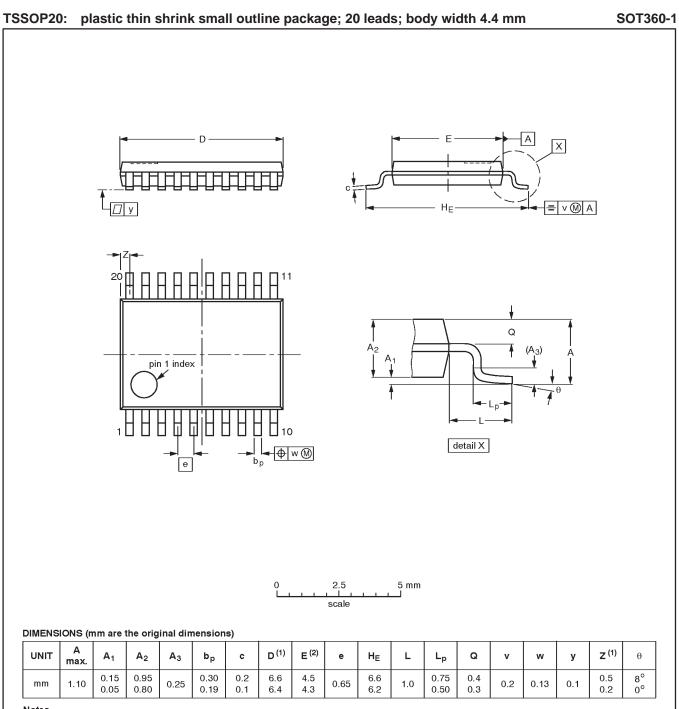
### 74LVC574A



## 74LVC574A



### 74LVC574A



#### Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT360-1		MO-153AC			<del>-93-06-16</del> 95-02-04

## 74LVC574A

#### Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1] Please consult the most recently issued datasheet before initiating or completing a design.

#### Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition - Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information - Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

#### Disclaimers

Life support — These products are not designed for use in life support appliances, devices or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no license or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

**Philips Semiconductors** 811 East Argues Avenue P.O. Box 3409 Sunnyvale, California 94088-3409 Telephone 800-234-7381

© Copyright Philips Electronics North America Corporation 1998 All rights reserved. Printed in U.S.A.

print code Document order number: Date of release: 08-98 9397-750-04514

Let's make things better.





This datasheet has been download from:

www.datasheetcatalog.com

Datasheets for electronics components.